

Description

The APG100N10D uses advanced APM-SGTII technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = 100V I_{D} = 100A$

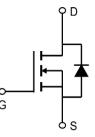
 $R_{DS(ON)} < 8.0 \text{m}\Omega$ @ $V_{GS} = 10 \text{V}$ (Type: 6.0 m Ω)

Application

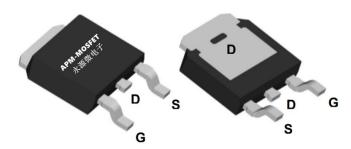
Isolated DC

Motor control

Synchronous-rectification







Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
APG100N10D	TO-252-3L	APG100N10D XXX YYYY	2500

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units	
VDS	Drain-Source Voltage	100	V	
VGS	Gate-Source Voltage	±20	V	
ID@T _A =25°C	Continuous Drain Current ¹	100	А	
I _D @T _A =70°C	Continuous Drain Current ¹	68	А	
IDM	Pulsed Drain Current ²	210	А	
EAS	Single Pulse Avalanche Energy ³	100	mJ	
IAS	Avalanche Current	40	Α	
P _D @T _A =25°C	Total Power Dissipation ⁴	100	W	
TSTG	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
R₀JA	Thermal Resistance Junction-Ambient ¹	62	°C/W	
$R_{\theta}JC$	Thermal Resistance Junction-Case ¹	1.25	°C/W	

°C/W





Electrical Characteristics (T_c=25 ℃ unless otherwise noted)

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100	108		V	
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =13.5A		6.0	8.0	mΩ	
NDO(ON)	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =11.5A		8.7	10.5		
VGS(th)	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D =250uA	1.2	1.8	2.3	V	
IDSS	Drain-Source Leakage Current	V _{DS} =80V , V _{GS} =0V , T _J =25°C			1	uA	
1033	Diain-Source Leakage Current	V _{DS} =80V , V _{GS} =0V , T _J =55°C			5	- uA	
IGSS	Gate-Source Leakage Current	V_{GS} =±20 V , V_{DS} =0 V			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =13.5A		75		S	
Qg	Total Gate Charge (10V)			45			
Qg	Total Gate Charge (4.5V)	VDS=50V , VGS=10V ,		19.3		nC	
Qgs	Gate-Source Charge	ID=13.5A		9.5		IIC	
Qgd	Gate-Drain Charge			4.8			
Td(on)	Turn-On Delay Time			10			
Tr	Rise Time	VDD=50V , VGS=10V ,		6.5			
Td(off)	Turn-Off Delay Time	- RG=3Ω, ID=13.5A		45		ns	
Tf	Fall Time			7.5			
Ciss	Input Capacitance			3320			
Coss	Output Capacitance	VDS=50V , VGS=0V , f=1MHz		605		pF	
Crss	Reverse Transfer Capacitance			20			
IS	Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current			5	Α	
VSD	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.1	V	
trr	Reverse Recovery Time	IF=13.5A , di/dt=100A/μs ,		33		nS	
Qrr	Reverse Recovery Charge	Tյ=25°C		150		nC	

Note:

- 1. The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- $3\$ The EAS data shows Max. rating . The test condition is VDD=72V,VGS=10V, L=0.1mH IAS=40A
- 4. The power dissipation is limited by 150°C junction temperature
- 5 The data is theoretically the same as I D and I DM , in real applications , should be limited by total power dissipation

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Typical Characteristics

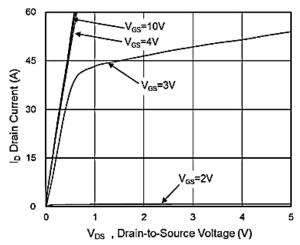


Fig.1 Typical Output Characteristics

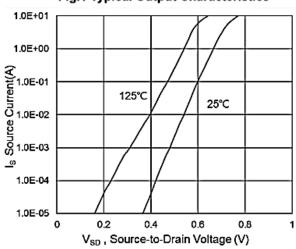


Fig.3 Source-Drain Forward Characteristics

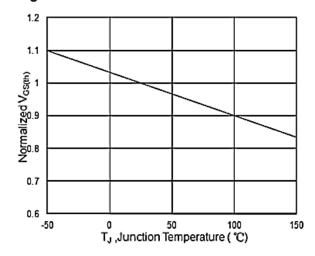


Fig.5 Normalized V_{GS(th)} vs. T_J

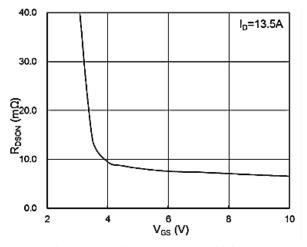


Fig.2 On-Resistance vs. G-S Voltage

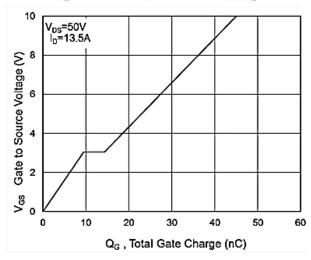


Fig.4 Gate-Charge Characteristics

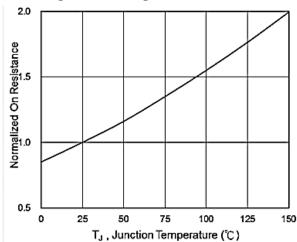
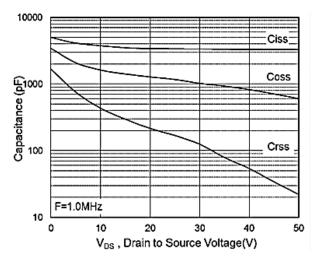


Fig.6 Normalized RDSON vs. TJ







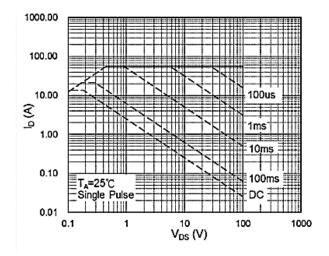


Fig.7 Capacitance

Fig.8 Safe Operating Area

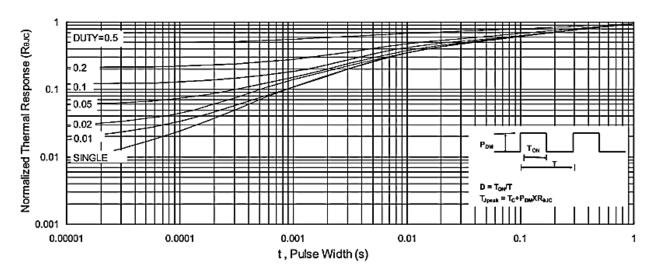
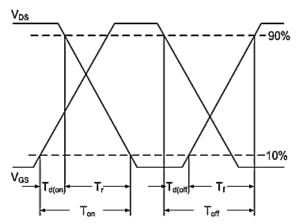


Fig.9 Normalized Maximum Transient Thermal Impedance





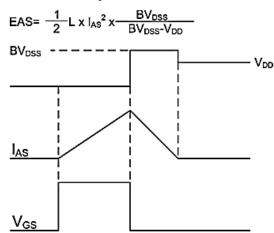
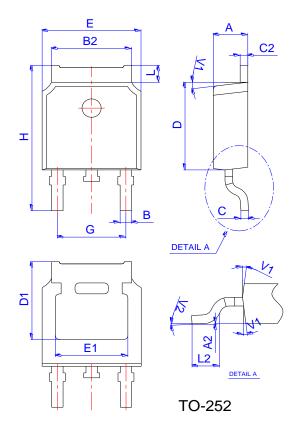


Fig.11 Unclamped Inductive Switching Waveform

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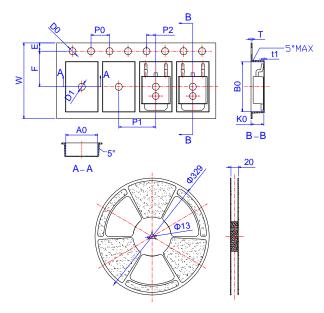


Package Mechanical Data:TO-252-3L



	Dimensions					
Ref.	Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
В	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
С	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
Е	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
Н	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Spectification-TO-252



	Dimensions					
Ref.		Millimeters		Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
В0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
Т	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583



APG100N10D

100V N-Channel Enhancement Mode MOSFET

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APG100N10D

100V N-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve1.0	2021/1/31	Initial release

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